

## **JD-727**

# Solvent Free Silicone Coating

UL File No. E526815

#### **Features**

- A solvent free, low viscosity, 100% solid content silicone coating.
- Fluoresces under U.V. light for fault inspection.
- Moisture curing, reacts with humidity in the air to form an elastic protective layer.
- Cured at room temperature or with heat.
- After cured, it has good insulation, moisture resistance, and cushioning properties.
- Suitable for most substrates and adheres well, it is widely used for protecting and insulating purposes in circuit boards or electronic components.
- Compliance with UL94 V-0, and RoHS Directive.

## **Physical Properties**

Appearance : Translucent liquid

Viscosity :  $500 \sim 600 \text{ cps}$ 

Specific Gravity : 0.95 ~ 1.05

Tack Free Time : @25°C 10 ~ 15 mins (depends on coating thickness)

Cure Time : 25°C x 24 hrs

\*For heat curing: Below 60°C, simultaneously

increase humidity (RH55~75%).

Hardness : Shore A  $30 \sim 36$ 

Temperature Range :  $-40^{\circ}\text{C} \sim +200^{\circ}\text{C}$ 

Glass Transition Temperature (Tg) : <40°C

Dielectric Strength : 20 kV/mm

Tensile Strength : 0.5 MPa

Elongation : 60%

Volume Resistivity :  $1.5 \times 10^{14} \text{ ohm} \cdot \text{cm}$ 

Dielectric Constant : 1MHz 3.0

Dielectric Dissipation Factor : 1MHz 4 x 10<sup>-3</sup>

Shelf Life : @25°C, Unopened 6 Months

## Handling & Storage

- For high strength bonding, clean the contact surface to remove dust, grease and all other contaminants before applying the adhesive.
- After contacting with moisture in air, JD-727 will start curing from the surfaces to inner sections. The curing speed is related to the thickness of JD-727 applied, humidity in air and temperature. The thicker JD-727 applied or the lower the relative humidity is, the longer the curing time will be. Hence, heat curing may be considered.
- After opened, the container must be sealed tightly to avoid water contamination which will reduce the shelf life of the remaining product.